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rev 2.0, 20.11.2017

LED980-02

- Infrared LED
- 980 nm, 17 mW
- Chip: GaAs, 350 x 350 µm
- 5 mm Clear Molding, Epoxy Resin
- Viewing Angle: 18°

Description

LED980-02 contains a GaAs LED mounted on a lead frame hermetically sealed with a clear epoxy lens. On forward bias, it emits a power radiation of typical **17 mW** at a peak wavelength at **980 nm**.

Maximum Ratings (T_{CASE}=25°C)

Parameter	Symbol	Values Min.	Values Max.	Unit
Power Dissipation	P_D		140	mW
Forward Current	I_F		100	mA
Pulse Forward Current *1	I_{FP}		1000	mA
Reverse Voltage	V_F		5	V
Thermal Resistance	R_{THJA}		250	K/W
Junction Temperature	T_J		120	°C
Operating Temperature	T_{CASE}	- 40	+ 100	°C
Storage Temperature	T_{STG}	- 40	+ 100	°C
Lead Solder Temperature *2	T_{SLD}		+ 265	°C

*1 *duty=1%, pulse width = 10 µs*
*2 *must be completed within 3 seconds*

Electro-Optical Characteristics (T_{CASE}=25°C)

Parameter	Symbol	Conditions	Values Min.	Values Typ.	Values Max.	Unit
Peak Wavelength	λ_P	I_F=50mA	970		990	nm
Half Width	$\Delta\lambda$	I_F=50mA		37		nm
Forward Voltage	V_F	I_F=50mA		1.3	1.4	V
	V_{FP}	I_{FP}=1A		2.1		
Radiated Power *1	P_O	I_F=50mA		17		mW
		I_{FP}=1A		150		
Radiant Intensity *2	I_E	I_F=50mA		170		mW/sr
		I_{FP}=1A		1500		
Viewing Angle	φ	I_F=50mA		18		deg.
Rise Time	t_R	I_F=50mA		15		ns
Fall Time	t_F	I_F=50mA		15		ns

*1 *measured by S3584,08*
*2 *measured by CIE127-2007 Condition B*

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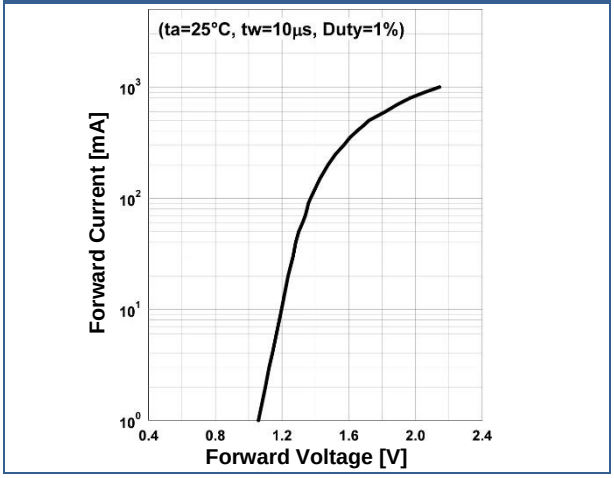
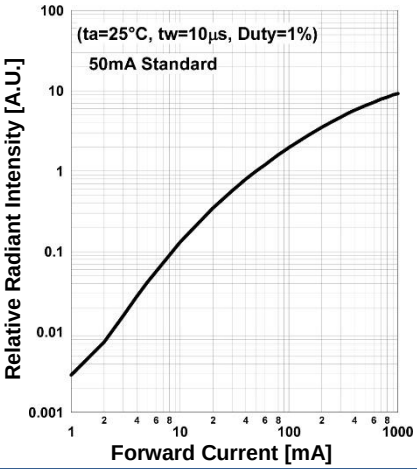
Typical Performance Curves

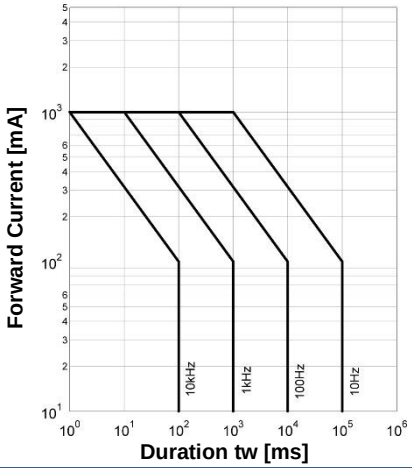
Forward Current vs. Forward Voltage



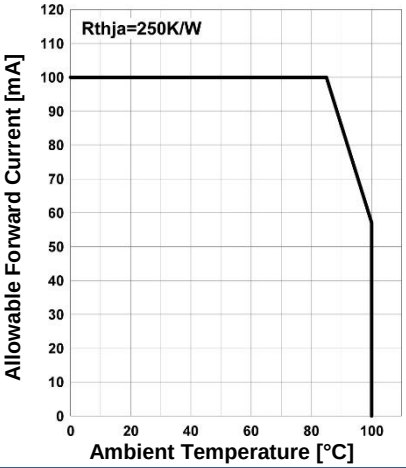
Rel. Radiant Intensity vs. Forward Current



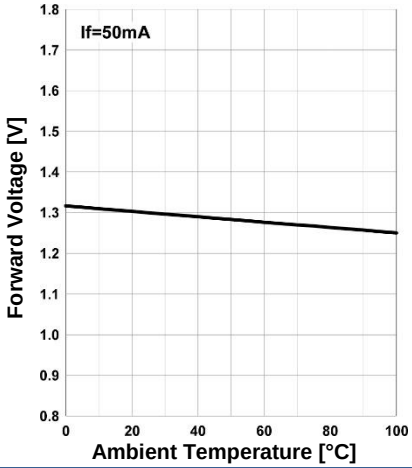
Forward Current vs. Pulse Duration



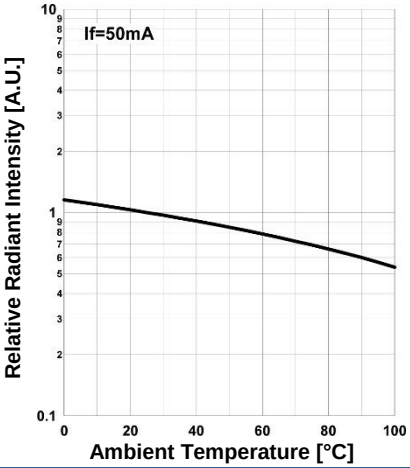
Allowed Forward Current vs. Ambient Temperature



Forward Voltage vs. Ambient Temperature



Rel. Radiant Intensity vs. Ambient Temperature



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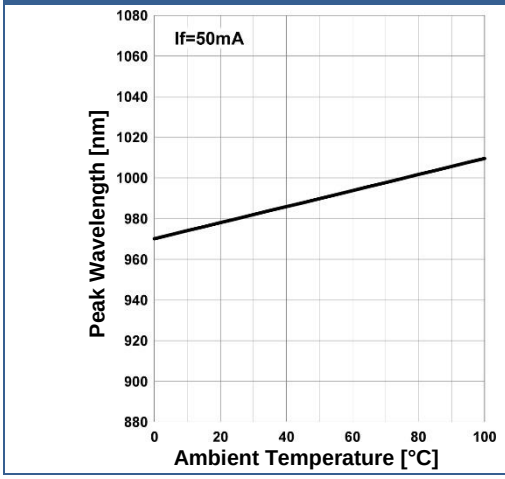
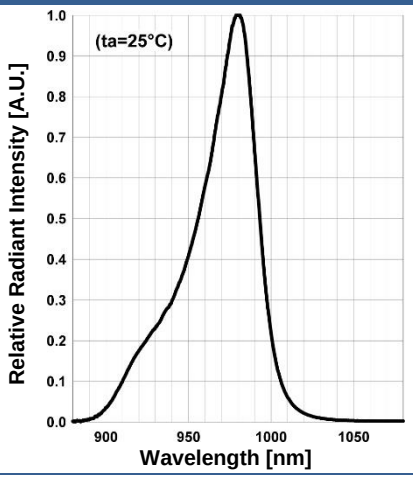
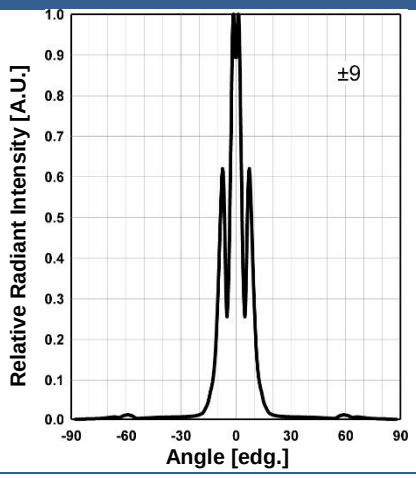
Peak Wavelength vs. Ambient Temperature



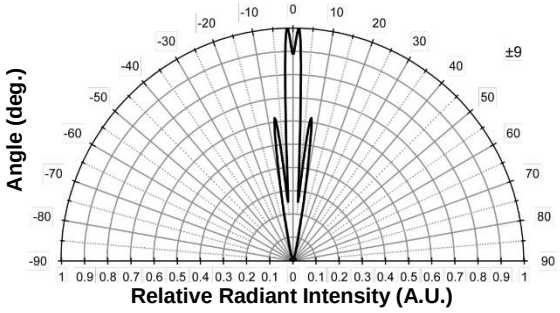
Relative Spectral Emission



Radiation Characteristics

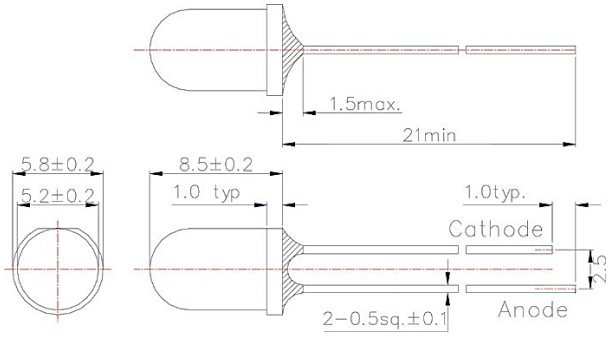


Radiation Characteristics



Outline Dimensions

LED980-02 **5 mm**



Lead	Description
Short Pin	LED Cathode
Large Pin	LED Anode

All Dimensions in mm

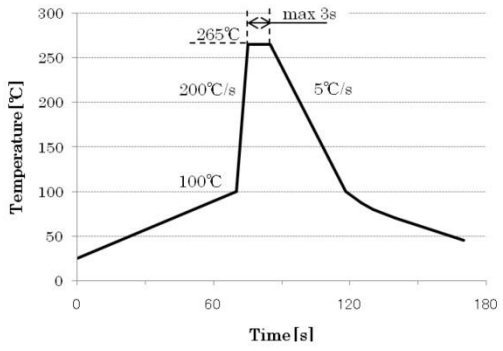
Precautions

Soldering:

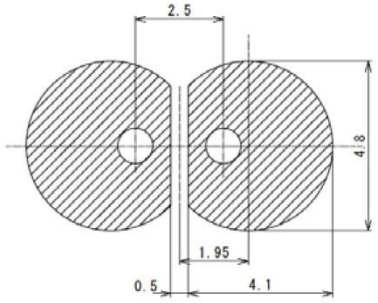
- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering
- Do not solder the LED closer than 3 mm from the base of the lead.

Recommended soldering conditions:

Soldering Conditions



Recommended Soldering Patterns



Unit: mm

Above table specifies the maximum allowed duration and temperature during soldering. It is strongly advised to perform soldering at the shortest time and lowest temperature possible.

Cleaning:

Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended
DO NOT USE acetone, chloroseen, trichloroethylene, or MKS
DO NOT USE ultrasonic cleaners

Static Electricity:

LEDs are sensitive to electrostatic discharge (ESD). Precautions against ESD must be taken when handling or operating these LEDs. Surge voltage or electrostatic discharge can result in complete failure of the device.

Radiation:

During operation these LEDs do emit light, which could be hazardous to skin and eyes, and may cause cancer. Do avoid exposure to the emitted light. Protective glasses if needed. It is further advised to attach a warning label on products/systems.

Operation:

Do *only* operate LEDs with a current source.
Running these LEDs from a voltage source will result in complete failure of the device.
Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.